Pulse Processing: Preamplifiers and Noise

Nuclear Instrumentation Lecture 2



Learning Objectives

After this lecture you should understand:

- Operation of charge-sensitive and current-sensitive preamplifiers
- Pulse pile-up and recovery
- Sources of electronic noise
- Energy resolution factors

Preamplifiers

Primary function:

• To extract the signal from the detector with minimum signal-to-noise degradation



Preamplifiers

• Locate close to the detector (to minimize capacitive loading).

Several types of detector produce moderately large outputs. e.g:

- · Photodiodes operating in intense light
- Photomultiplier tubes (PM tubes)
- Scintillation detectors mounted on a PM tube
- Microchannel plates

For such detectors, use a current-sensitive preamplifier

High-resolution systems

More care needs to be taken for **high-resolution systems**. Detectors in this category include:

- Silicon (Si) detectors
- Germanium (Ge) detectors
- · Gas proportional counters.

These produce very small output signals. Therefore, the preamp input stage should contribute little noise.

This requirement is often met by using a charge-sensitive preamplifier:

- with FET input stage.
- cooled FET (reduce thermal noise).



Charge-sensitive preamplifier



- The diagram shows charges, voltages and essential elements in a chargesensitive preamp.
- Output voltage proportional to total integrated charge: $V_0 = Q_D / C_f$
- Risetime depends on the charge collection characteristics of the detector
- Decay time constant $\mathbf{\tau}_0 = \mathbf{R}_f \mathbf{C}_f$

Charge-sensitive preamplifier

- R_{ℓ} is a source of electronic noise: It should be as large as possible.
- Electronic noise in charge-sensitive preamps is generally controlled by **four** components:
 - 1. The input field-effect transistor (FET).
 - 2. The total capacitance of the input (detector capacitance, cables etc.).
 - 3. The resistance connected to the input.
 - 4. Input leakage currents from the detector and FET.
- The FET is selected for low-noise performance and often is cooled to almost LN₂ temperature to reduce thermal noise.

Preamplifier sensitivity

- **Preamplifier sensitivity** given as output voltage per unit of deposited energy e.g. mV/MeV.
- Charge delivered by a detector to its preamp:

 $Q_D = [Ee \times 10^6]/\varepsilon$

E = energy in MeV deposited in the detector, ε = avg energy (eV) to produce an electron-hole (e-h) pair e = electronic charge (1.6×10⁶ C).

Output voltage: Hence, sensitivity:
$$\begin{split} V_0 &= Q_D/C_f = Ee \times 10^6/\epsilon C_f \\ V_0/E &= e \times 10^6/\epsilon C_f \,. \end{split}$$

Current-sensitive preamplifier

For less demanding requirements:

- When the detector gives ~ large, fast rising pulses, use a terminated 50-ohm cable attached to the detector output.
- The current pulse develops the desired voltage across the load presented by the cable).
- For scintillators mounted on PM tubes, this signal is usually large enough to drive a fast discriminator without additional amplification.

For smaller pulses (single-photon counting, etc), additional amplification may be provided by a **current-sensitive preamplifier**.

Current-sensitive preamplifier



• The 50-ohm input impedance is chosen to match the impedance of the cable.

• Current pulse is converted to a voltage pulse:

$$V_{out} = 50 I_{in} A$$

A = preamp gain

 ${\rm I}_{\rm in}$ = amplitude of the detector current pulse

For timing applications, this signal can drive input of a counter/rate meter

Limitation on timing resolution with PM tubes • Fluctuation in the transit time of the electrons through the PM tube causes jitter in the arrival time of the pulse at the detector output. Incident Photoelectron Dynodes Radiation Anode Output Voltage Interaction Point Photocathode • Preamplifier input noise: causes uncertainty (jitter) in the time at which the pulse crosses the threshold of a timing discriminator. To minimize this effect: choose a preamplifier rise time $\tau_{rise} \sim or < detector rise time.$ Choosing $\tau_{rise} \leq than that of the detector output does not help.$ In fact, it is a source of additional noise.







Parallel noise

There are two main sources of parallel noise

- Shot noise: Leakage currents through the detector and its circuitry
- **Thermal noise:** Thermal motion of electrons in critical resistors, (preamplifier feedback resistor and the detector bias resistor)

Each source is treated as an **effective noise-current generator** at the input to the preamplifier.

Shot noise

Current = a series of discrete pulses of equal height arriving randomly in time.

- 1 pulse \equiv unit of charge e (an electron or hole)
- Current pulse $\equiv e\delta(t)$, where $\delta(t)$ is the delta function and $\int e\delta(t)dt = e$



• Leakage current $i_L = ne$, where n = average pulse rate.

• If amplifier shaping time = τ , approx. N $\approx n\tau$ pulses will have elapsed during the period of the signal pulse.

• Thus, the average leakage charge collected in time τ : Q_{av} = Ne.

Shot noise

- Pulses arrive randomly in time and so N is subject to Poisson statistics, i.e. N has a standard deviation of \sqrt{N} and a relative standard deviation of $1/\sqrt{N}$.
- Therefore, the actual charge collected will exhibit a **statistical variation** observed as **noise** on the signal.
- Noise is quoted as the **variance** (standard deviation)² of Q_{av} :

$$(\omega)^{2}_{shot} = (Q_{av} / \sqrt{N})^{2} = N e^{2}$$

which can be written as

 $(\omega)^2_{\text{shot}} = n e^2 \tau = e i_{\text{L}} \tau$

after substituting for N and $i_{\rm L}$

Note that the units are $(charge)^2$

Shot noise

Example: We use the above general arguments and our knowledge of detectors to estimate the effect of shot noise on the signal from a germanium detector.

- Suppose the detector leakage current is 1 nA. This is equivalent to a flow rate $n \sim 6 \times 10^9$ electrons per second.
- If we have set a shaping time constant τ of 6 µs, $N = n\tau \sim 4 \times 10^4$ and $\sqrt{N} \sim 200$.

• In a germanium detector, about 3 eV is required to create an electron-hole pair. So, a variation of 200 charge carriers is equivalent to **600 eV** of noise on the energy signal.

Thermal noise

Arises from the thermal motion of charge carriers in a resistor, the most important being the preamplifier feedback resistor R.

- The motion is driven by thermal energy kT where k = Boltzmann's constant.
- kT is the thermal energy of an electron in the resistor R.
- Consider motion (energy) to be due to a varying (effective) voltage V across the resistor, giving energy eV = kT to the electrons
- The voltage V generates a (thermal) current $i_{th} = V/R$.
- This current can be treated as an effective input source like shot noise.
- Thermal noise variance:

 $(\omega)^2_{th} \approx e i_{th} \tau = [eV/R] \tau = [kT/R] \tau$

after substituting for ith and eV.

Thermal noise

A proper calculation gives

$$(\omega)^2_{\text{th}} \approx [4 \text{kT}/\text{R}] \tau$$

Combining shot noise and thermal noise:

$$(\omega)^2_{\text{parallel}} \approx e i_L \tau + [4kT/R] \tau$$

NB both terms have **same** dependence on the shaping time constant τ .

Parallel noise is minimized by

- Reducing T (cooling the feedback and bias resistors).
- Using a large feedback resistor (or an autoset preamplifier).
- Using a short shaping time constant τ.

Series Noise

- Due to leakage current i_D in the preamplifier FET.
- Has a different dependence on τ to that of shot noise or thermal noise.

 \bullet This is because $i_{\rm D}$ is a property of the transistor (and its temperature) and is not dependent on $\tau.$

Consider i_D = electrons flowing at a rate n per unit time, i.e.

$$i_D = ne.$$

During the shaping time τ , a number $N = n\tau$ electrons will have been collected.

N will fluctuate (Poisson statistics), hence, the output current will fluctuate:

 $i_D = ne = Ne/\tau \pm \sqrt{N} e/\tau = ne \pm \sqrt{n} e/\sqrt{\tau}$

• Variance: (standard deviation)² of the FET current $\propto ne^2/\tau$.

Output voltage due to FET leakage is proportional to i_D and so the variance in the output (series noise) will also vary as $1/\tau$ (not directly with τ as we found with parallel noise).

Series noise

Thus we have

$$(\omega)^2_{\text{series}} \approx ne^2/\tau$$

Series noise depends on

- **Temperature** \rightarrow because FET leakage depends on temperature.
- Input capacitance C_{i.}
- FET transconductance g.

To see this, we calculate i_D as if it were due to an **effective noise** source i_S at the input to the preamplifier.



Series noise

The transconductance of a transistor is

 $g = \partial i_D / \partial V_{G_L}$

Thus, $\Delta V_{G}\,at$ the FET input generates an FET drain current:

$$\Delta i_D = g \Delta V_G = g e / C_i$$

Alternatively, an FET drain current $\Delta i_D = e$ would result from an amount of charge $C_i e/g$, from an effective input source, collected on C_i .

Hence, we rewrite $(\omega)^2_{\text{series}}$ as being due to effective shot noise at the preamp input, by replacing e with $C_i e/g$. i.e.

$$(\omega)_{\text{series}}^2 \propto \left(\frac{C_i}{g}\right)^2 \frac{e^2 n}{\tau}$$

Series noise

The temperature dependence is contained in the quantity n, and is obtained from an approximate relationship between transistor drain current i_D and gate voltage V_G : $i_D \approx \exp(e V_G / kT)$



N.B. This is **not** a proper derivation of series noise. However, apart from numerical constants, it is the expression for series noise given by a more rigorous calculation.

Series noise

Series noise is minimized by

• Reducing the input impedance C_i (length of connecting leads etc.).

• Lowering the temperature (cooling the FET and feedback resistor).

- Using a high gain (g), low-noise FET.
- Increasing the shaping time.

Flicker noise

There is a third noise source, flicker noise, \sim independent of τ .

• It arises from currents in all active components and increases with count rate.

• It is generally << parallel or series noise.

Noise and amplifier shaping time



- $(\omega)^2_{\text{series}}$ decreases with τ .
- $(\omega)^2_{\text{parallel}}$ increases with τ .
- Optimum τ gives a **minimum** in the total electronic noise level.

The plots vary depending on particular detector & electronics used.

- e.g. $(\omega)^2_{parallel}$ is reduced by using an auto-reset preamplifier (no feedback resistor).
- Reducing $(\omega)^2_{\text{parallel}}$ shifts the minimum to a longer time constant.
- This may be undesirable if the counting rate is very high.



Energy Resolution

Interaction of radiation with matter a statistical process (probability for any given collision/excitation/absorption)

After all energy is deposited, charge collection is also statistical (Poisson)

$$\Omega = \sqrt{N}$$

 $FWHM = 2.354\sigma$

σ

Ν

number of collected charges

At large N, distribution becomes Gaussian

requency of occurrence



Statistical fluctuations in the number of charge carriers per interaction event (N_{pair}) is given by $(2, 25)^2 T$

$$(\Delta E_S)^2 = \frac{(2.35)^2 F}{N_{pair}}$$

F is the fano factor accounting for deviation from Poisson statistics of experimentally observed statistical fluctuations

Total energy resolution: electronic Noise, Statistical fluctuations in # of charge carriers and incomplete Charge collection

$$(\Delta_T)^2 = (\Delta_N)^2 + (\Delta_S)^2 + (\Delta_C)^2$$



Summary

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